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## **CLAIMS**

We claim:

1. A polishing method comprising the steps of:

forming a layer made of material containing a metal as a main component over a substrate having recessed portions on a surface thereof so as to fill said recessed portions with said metal layer; and

polishing said metal layer by a chemical mechanical polishing method using a slurry including a polishing agent containing

a chemical agent being responsible for forming a protective film on the surface of said metal layer by reacting with said material containing a metal as a main component, wherein said chemical agent includes at least a carbonyl derivative of benzotriazole, and

an etching agent being responsible for etching said material containing a metal as a main component.

2. The method of claim 1, wherein said carbonyl derivative of benzotriazole has the formula

where R is selected from the group consisting of - CH<sub>3</sub> (methyl), - CH<sub>2</sub>CH<sub>3</sub> (ethyl), - CH<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub> (propyl), - CH<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub> (n-butyl), - C(CH<sub>3</sub>)<sub>3</sub> (tertbutyl), p-tolyl, 1 – Benzotriazolyl – 1 – butamido, 2 – pyridyl, 3 – pyridyl, 4 – pyridyl, 2 – thiophenyl, and 3 – thiophenyl.

- 3. The method of claim 1, wherein said etching agent includes an oxidizer; an acid or base; and a buffering agent or organic amine.
- 4. The method of claim 1, wherein said etching agent includes an oxidizer selected from the group consisting of  $H_2O_2$ ,  $KIO_3$ , and  $Fe^{3+}$ ; HF or  $(CH_3)N(OH)$ ; and a buffering agent or organic amine selected from the group consisting of  $NH_4(CH_3CO_2)$ , alkanol amine, and amino acid.
- 5. The method of claim 1, wherein said carbonyl derivative of benzotriazole comprises from about 0.0001 to 10% of said polishing agent.
- 6. The method of claim 1, wherein said carbonyl derivative of benzotriazole comprises from about 0.01 to 5.00% of said slurry.
- 7. The method of claim 1, wherein said metal is selected from the group comprising Cu, an Cu alloy, Al, and an Al alloy.

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8. A polishing method comprising the steps of:

forming a film made of material containing a metal as a main component over a substrate having recessed portions on a surface thereof so as to fill said recessed portions with said film; and

polishing said film by a chemical mechanical polishing method using a slurry including a polishing agent containing

a chemical agent being responsible for forming a protective film on the surface of said film by reacting with said material containing a metal as a main component, and

an etching agent being responsible for etching said material containing a metal as a main component; thereby forming a conductive film in said recessed portions, wherein said metal is Cu or a Cu alloy and said chemical agent includes at least includes at least a carbonyl derivative of benzotriazole.

9. The method of claim 8, wherein said carbonyl derivative of benzotriazole has the formula

where R is selected from the group consisting of - CH<sub>3</sub> (methyl), - CH<sub>2</sub>CH<sub>3</sub> (ethyl), - CH<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub> (propyl), - CH<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub> (n-butyl), - C(CH<sub>3</sub>)<sub>3</sub> (tertbutyl), p-tolyl, 1 - Benzotriazolyl - 1 - butamido, 2 - pyridyl, 3 - pyridyl, 4 - pyridyl, 2 - thiophenyl, and 3 - thiophenyl.

- 10. The method of claim 8, wherein said etching agent includes an oxidizer; an acid or base; and a buffering agent or organic amine.
- 11. The method of claim 8, wherein said etching agent includes an oxidizer selected from the group consisting of  $H_2O_2$ ,  $KIO_3$ , and  $Fe^{3+}$ ; HF or  $(CH_3)N(OH)$ ; and a buffering agent or organic amine selected from the group consisting of  $NH_4(CH_3CO_2)$ , alkanol amine, and amino acid.
- 12. The method of claim 8, wherein said carbonyl derivative of benzotriazole comprises from about 0.0001 to 10% of said slurry.
- 13. The method of claim 8, wherein said carbonyl derivative of benzotriazole comprises from about 0.01 to 5.00% of said slurry.
- 14. A polishing method comprising the steps\of:

forming a film made of material containing a metal as a main component over a substrate having recessed portions on a surface thereof so as to fill said recessed portions with said kilm; and

5 polishing said film by a chemical mechanical polishing method using a slurry including a polishing agent containing

> a chemical agent being responsible for forming a protective film on the surface of said film by reacting with said material containing a metal as a main component, and

an etching agent being responsible for etching said material containing a metal as a main component;

thereby forming a conductive film in said recessed portions,

wherein said metal is Cu or a Cu alloy and said chemical agent includes at least includes at least a carbonyl derivative of benzotriazole having the formula

where R is selected from the group consisting of - CH<sub>3</sub> (methyl), - CH<sub>2</sub>CH<sub>3</sub> 20 (ethyl), - CH2CH2CH3 (propyl), - CH2CH2CH2CH3 (n-butyl), - C(CH3)3 (tertbutyl), p-tolyl, 1 – Benzotriazolyl – 1 – butamido, 2 – pyridyl, 3 – pyridyl, 4 – pyridyl, 2 – thiophenyl, and 3 – thiophenyl.

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- 15. The method of claim 14, wherein said etching agent includes an oxidizer; an acid or base; and a buffering agent or organic amine.
- 16. The method of claim  $^{14}$ , wherein said etching agent includes an oxidizer selected from the group consisting of  $H_2O_2$ ,  $KIO_3$ , and  $Fe^{3+}$ ; HF or  $(CH_3)N(OH)$ ; and a buffering agent or organic amine selected from the group consisting of  $NH_4(CH_3CO_2)$ , alkanol amine, and amino acid.
- 17. The method of claim 14, wherein said carbonyl derivative of benzotriazole comprises from about 0.000 to 10% of said slurry.
- 18. The method of claim 14, wherein said carbonyl derivative of benzotriazole comprises from about 0.01 to 5.00% of said slurry.